



Attorney's Docket No.: 42P17182

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)

Saikumar Jayaraman et al.)

U.S. Serial No: 10/676,548)

Filed: September 30, 2003)

For: STRESS COMPENSATION LAYER)
SYSTEMS FOR IMPROVED SECOND)
LEVEL SOLDER JOINT RELIABILITY)

Examiner: Norris, Jeremy C.

Art Unit: 2841

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed March 25, 2005. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

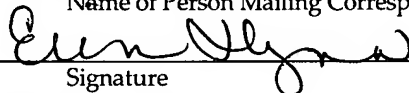
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